

# PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Ralf Otremba	12/05/2007
Xaver Schloegel	12/05/2007
Rupert Fischer	12/10/2007
Tien Lai Tan	12/20/2007
RECEIVING PARTY DATA	
Name:	Infineon Technologies AG
Street Address:	Am Campeon 1-12
City:	Neubiberg
State/Country:	GERMANY
Postal Code:	85579
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	11944724
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Address Line 4:	Minneapolis, MINNESOTA 55402
ATTORNEY DOCKET NUMBER:	I446.184.101/I0794US
NAME OF SUBMITTER:	Steven E. Dicke
Total Attachments: 3	

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**PATENT**  
**REEL: 020521 FRAME: 0417**

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**PATENT**

**REEL: 020521 FRAME: 0418**

### ASSIGNMENT

For good and valuable consideration, I, Ralf Otremba, a citizen of Germany, residing at Ahornstr. 42, 87600 Kaufbeuren, Germany; Xaver Schloegel, a citizen of Germany, residing at Raiffeisenstr. 22, 83679 Sachsenkam, Germany; Rupert Fischer, a citizen of Germany, residing at Bahnhofstr. 45, 93142 Maxhuetten-Haidhof, Germany; and Tien Lai Tan, a citizen of Malaysia, residing at 25, Jalan Seri Jati 1/3, Taman Seri Jati, Batu, Berendam, 75350 Melaka, Malaysia, hereinafter individually or collectively referred to as "Assignor";

Hereby sell, assign and transfer to **Infineon Technologies AG**, a corporation, organized and existing under the laws of Germany, having its principal place of business at Am Campeon 1-12, 85579 Neubiberg, Germany, hereinafter "Assignee", its successors, assigns and legal representatives, the entire right, title and interest in and for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, which has been executed by the undersigned and was filed on November 26, 2007 as U.S. Application No. 11/944,724, entitled:

#### METHOD FOR MAKING A DEVICE INCLUDING PLACING A SEMICONDUCTOR CHIP ON A SUBSTRATE

and in and to said application and all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be filed in the United States and all foreign countries on said improvements;

Agree that said Assignee may apply for and receive Letters Patent for said improvements in its own name; and that, when requested, without charge to but at the expense of said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and legal representatives, all facts known to the undersigned relating to said improvements and the history thereof; and generally do everything possible which said Assignee, its successors, assigns or legal representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns and legal representatives; and

Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

SIGNATURE: \_\_\_\_\_

NAME: Ralf Otremba

DATE: 05.12.2007

INFINEON REF NO. I0794US  
O.C. REF NO. I446.184.101

SIGNATURE: \_\_\_\_\_

NAME: Xaver Schlögl

DATE: \_\_\_\_\_

5.12.07

SIGNATURE: \_\_\_\_\_

NAME: Rupert Fischer

DATE: \_\_\_\_\_

10.12.07

SIGNATURE: \_\_\_\_\_

NAME: Tien Lai Tan

DATE: \_\_\_\_\_

INFINEON REF NO. I0794US  
O.C. RBF NO. 1446.184.101

SIGNATURE: \_\_\_\_\_ DATE: \_\_\_\_\_  
NAME: Xaver Schloegel

SIGNATURE: \_\_\_\_\_ DATE: \_\_\_\_\_  
NAME: Rupert Fischer

SIGNATURE:  \_\_\_\_\_ DATE: 20/12/2007  
NAME: Tien Lai Tan